# **Switching Transistor**

# **PNP Silicon**

### **Features**

• Moisture Sensitivity Level: 1

• ESD Rating: Human Body Model; 4 kV,

Machine Model; 400 V

• Pb-Free Package is Available

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-40	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-40	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current – Continuous	Ic	-600	mAdc

### THERMAL CHARACTERISTICS

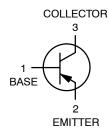
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board $T_A = 25^{\circ}C$	P <sub>D</sub>	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	833	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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SC-70 CASE 419 STYLE 3

### **MARKING DIAGRAM**



2T = Specific Device Code D = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMBT4403WT1	SC-70	3000/Tape & Reel
MMBT4403WT1G	SC-70 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Charac	teristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS		1			
Collector-Emitter Breakdown Voltage (Note 1) (I <sub>C</sub> = -1.0 mAdc, I <sub>B</sub> = 0)			-40	-	Vdc
Collector – Base Breakdown Voltage (I <sub>C</sub> = -0.	1 mAdc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	-40	-	Vdc
Emitter-Base Breakdown Voltage (I <sub>E</sub> = -0.1	mAdc, I <sub>C</sub> = 0)	V <sub>(BR)EBO</sub>	-5.0	-	Vdc
Base Cutoff Current ( $V_{CE} = -35 \text{ Vdc}$ , $V_{EB} = -35 \text{ Vdc}$	-0.4 Vdc)	I <sub>BEV</sub>	-	-0.1	μAdc
Collector Cutoff Current (V <sub>CE</sub> = -35 Vdc, V <sub>EE</sub>	<sub>3</sub> = -0.4 Vdc)	I <sub>CEX</sub>	-	-0.1	μAdc
ON CHARACTERISTICS		1		•	•
$\label{eq:DC Current Gain} \begin{array}{l} \text{(I}_{C} = -0.1 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -1.0 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -1.0 \text{ mAdc, V}_{CE} = -1.0 \text{ Vdc)} \\ \text{(I}_{C} = -150 \text{ mAdc, V}_{CE} = -2.0 \text{ Vdc)} \\ \text{(I}_{C} = -500 \text{ mAdc, V}_{CE} = -2.0 \text{ Vdc)} \end{array}$	(Note 1) (Note 1)	h <sub>FE</sub>	30 60 100 100 20	- - - 300 -	-
Collector – Emitter Saturation Voltage (Note 1 ( $I_C$ = -150 mAdc, $I_B$ = -15 mAdc) ( $I_C$ = -500 mAdc, $I_B$ = -50 mAdc)	)	V <sub>CE(sat)</sub>		-0.4 -0.75	Vdc
Base – Emitter Saturation Voltage (Note 1) $ (I_C = -150 \text{ mAdc}, I_B = -15 \text{ mAdc}) $ $ (I_C = -500 \text{ mAdc}, I_B = -50 \text{ mAdc}) $		V <sub>BE(sat)</sub>	-0.75 -	-0.95 -1.3	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain - Bandwidth Product (I <sub>C</sub> = -20 mAdc, V <sub>CE</sub> = -10 Vdc, f = 100 MHz)		f <sub>T</sub>	200	-	MHz
Collector-Base Capacitance (V <sub>CB</sub> = -10 Vdc	, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>cb</sub>	-	8.5	pF
Emitter-Base Capacitance (V <sub>BE</sub> = -0.5 Vdc, I <sub>C</sub> = 0, f = 1.0 MHz)		C <sub>eb</sub>	-	30	pF
Input Impedance (I <sub>C</sub> = -1.0 mAdc, V <sub>CE</sub> = -10 Vdc, f = 1.0 kHz)		h <sub>ie</sub>	1.5	15	kΩ
Voltage Feedback Ratio ( $I_C = -1.0 \text{ mAdc}$ , $V_{CE} = -10 \text{ Vdc}$ , $f = 1.0 \text{ kHz}$ )		h <sub>re</sub>	0.1	8.0	X 10 <sup>-4</sup>
Small-Signal Current Gain (I <sub>C</sub> = -1.0 mAdc, V <sub>CE</sub> = -10 Vdc, f = 1.0 kHz)		h <sub>fe</sub>	60	500	-
Output Admittance (I <sub>C</sub> = -1.0 mAdc, V <sub>CE</sub> = -10 Vdc, f = 1.0 kHz)		h <sub>oe</sub>	1.0	100	μmhos
SWITCHING CHARACTERISTICS					
Delay Time	(V <sub>CC</sub> = -30 Vdc, V <sub>EB</sub> = -2.0 Vdc,	t <sub>d</sub>	-	15	no
Rise Time	$I_{C} = -150 \text{ mAdc}, I_{B1} = -15 \text{ mAdc})$	t <sub>r</sub>	-	20	ns
Storage Time	(V <sub>CC</sub> = -30 Vdc, I <sub>C</sub> = -150 mAdc,	t <sub>s</sub>	-	225	
Fall Time	$I_{B1} = I_{B2} = -15 \text{ mAdc}$	t <sub>f</sub>	-	30	ns

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

## SWITCHING TIME EQUIVALENT TEST CIRCUIT

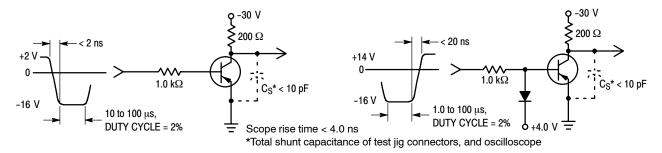


Figure 1. Turn-On Time

Figure 2. Turn-Off Time

### TRANSIENT CHARACTERISTICS

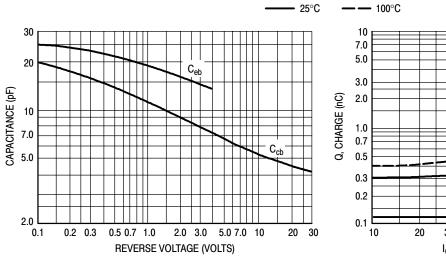
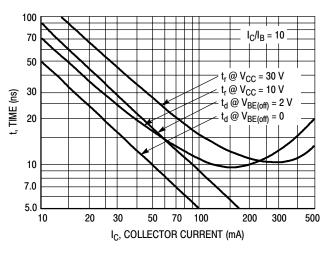


Figure 3. Capacitances

Figure 4. Charge Data



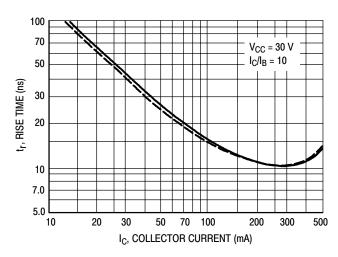


Figure 5. Turn-On Time

Figure 6. Rise Time

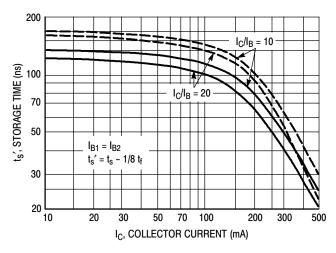


Figure 7. Storage Time

#### **SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE**

 $V_{CE} = -10 \text{ Vdc}$ ,  $T_A = 25^{\circ}\text{C}$ ; Bandwidth = 1.0 Hz

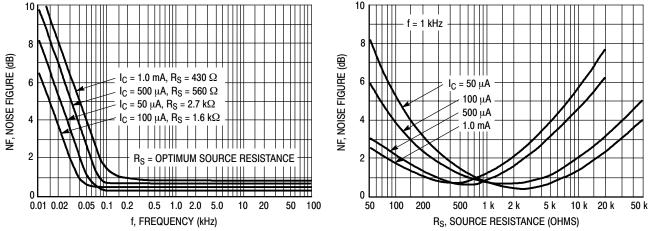


Figure 8. Frequency Effects

Figure 9. Source Resistance Effects

#### h PARAMETERS

 $V_{CE}$  = 10 Vdc, f = 1.0 kHz,  $T_A$  = 25°C

This group of graphs illustrates the relationship between  $h_{fe}$  and other "h" parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were selected from the MMBT4403LT1 lines, and the same units were used to develop the correspondingly numbered curves on each graph.

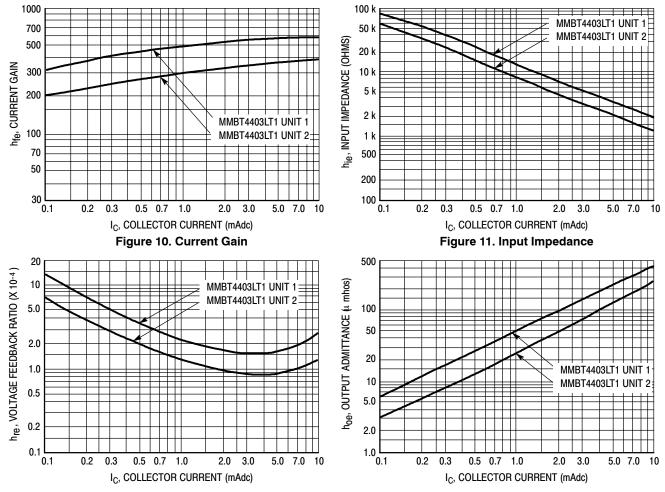


Figure 12. Voltage Feedback Ratio

Figure 13. Output Admittance

## STATIC CHARACTERISTICS

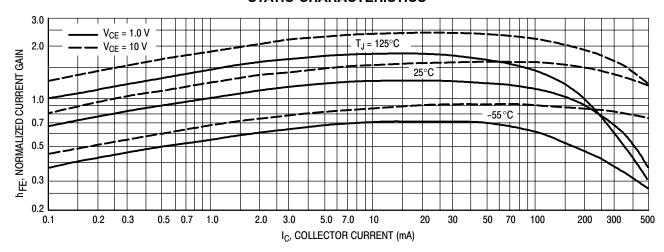


Figure 14. DC Current Gain

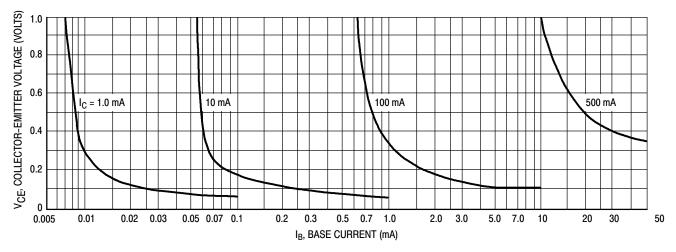


Figure 15. Collector Saturation Region

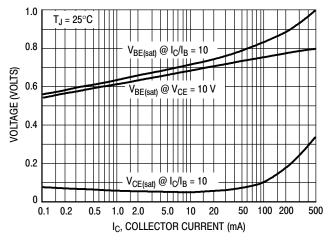


Figure 16. "On" Voltages

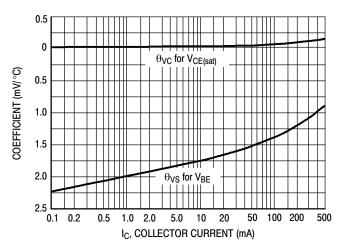
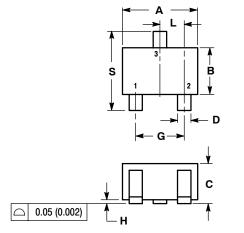
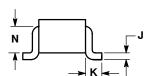


Figure 17. Temperature Coefficients

#### PACKAGE DIMENSIONS

SC-70/SOT-323 CASE 419-04 **ISSUE L** 





#### NOTES:

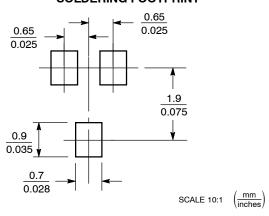
- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.032	0.040	0.80	1.00
D	0.012	0.016	0.30	0.40
G	0.047	0.055	1.20	1.40
Н	0.000	0.004	0.00	0.10
J	0.004	0.010	0.10	0.25
K	0.017 REF		0.425 REF	
L	0.026 BSC		0.650 BSC	
N	0.028 REF		0.700	REF
S	0.079	0.095	2.00	2.40

STYLE 3: PIN 1. BASE 2. EMITTER

3. COLLECTOR

#### **SOLDERING FOOTPRINT\***



#### SC-70/SOT-323

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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